Dual supply translating transceiver; 3-state Rev. 4 — 20 August 2010

Product data sheet

General description 1.

The 74LVC2T45; 74LVCH2T45 are dual bit, dual supply translating transceivers with 3-state outputs that enable bidirectional level translation. They feature two data input-output ports (nA and nB), a direction control input (DIR) and dual supply pins (V_{CC(A)} and $V_{CC(B)}$). Both $V_{CC(A)}$ and $V_{CC(B)}$ can be supplied at any voltage between 1.2 V and 5.5 V making the device suitable for translating between any of the low voltage nodes (1.2 V, 1.5 V, 1.8 V, 2.5 V, 3.3 V and 5.0 V). Pins nA and DIR are referenced to V_{CC(A)} and pins nB are referenced to V_{CC(B)}. A HIGH on DIR allows transmission from nA to nB and a LOW on DIR allows transmission from nB to nA.

The devices are fully specified for partial power-down applications using IOFF. The IOFF circuitry disables the output, preventing any damaging backflow current through the device when it is powered down. In suspend mode when either V_{CC(A)} or V_{CC(B)} are at GND level, both A port and B port are in the high-impedance OFF-state.

Active bus hold circuitry in the 74LVCH2T45 holds unused or floating data inputs at a valid logic level.

Features and benefits 2.

- Wide supply voltage range:
 - V_{CC(A)}: 1.2 V to 5.5 V
 - V_{CC(B)}: 1.2 V to 5.5 V
- High noise immunity
- Complies with JEDEC standards:
 - JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8C (2.7 V to 3.6 V)
 - JESD36 (4.5 V to 5.5 V)
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 4000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Maximum data rates:
 - 420 Mbps (3.3 V to 5.0 V translation)
 - 210 Mbps (translate to 3.3 V))
 - 140 Mbps (translate to 2.5 V)
 - 75 Mbps (translate to 1.8 V)
 - 60 Mbps (translate to 1.5 V)



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- Suspend mode
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- ± 24 mA output drive (V_{CC} = 3.0 V)
- Inputs accept voltages up to 5.5 V
- Low power consumption: 16 μA maximum I_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

Type number	Package							
	Temperature range Name		Description	Version				
74LVC2T45DC	–40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads;	SOT765-				
74LVCH2T45DC			body width 2.3 mm					
74LVC2T45GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads;	SOT833-				
74LVCH2T45GT			8 terminals; body 1 \times 1.95 \times 0.5 mm					
74LVC2T45GF	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads;	SOT1089				
74LVCH2T45GF			8 terminals; body $1.35 \times 1 \times 0.5$ mm					
74LVC2T45GD	–40 °C to +125 °C	XSON8U	plastic extremely thin small outline package; no leads;	SOT996-				
74LVCH2T45GD			8 terminals; UTLP based; body $3 \times 2 \times 0.5$ mm					
74LVC2T45GM	–40 °C to +125 °C	XQFN8U	plastic extremely thin quad flat package; no leads;	SOT902-				
74LVCH2T45GM			8 terminals; UTLP based; body $1.6 \times 1.6 \times 0.5$ mm					
74LVC2T45GN	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads;	SOT1116				
74LVCH2T45GN			8 terminals; body $1.2 \times 1.0 \times 0.35$ mm					
74LVC2T45GS	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads;	SOT1203				
74LVCH2T45GS			8 terminals; body $1.35 \times 1.0 \times 0.35$ mm					

4. Marking

Table 2. Marking	
Type number	Marking code ^[1]
74LVC2T45DC	V45
74LVCH2T45DC	X45
74LVC2T45GT	V45
74LVCH2T45GT	X45
74LVC2T45GF	V5
74LVCH2T45GF	X5
74LVC2T45GD	V45
74LVCH2T45GD	X45
74LVC2T45GM	V45
74LVCH2T45GM	X45

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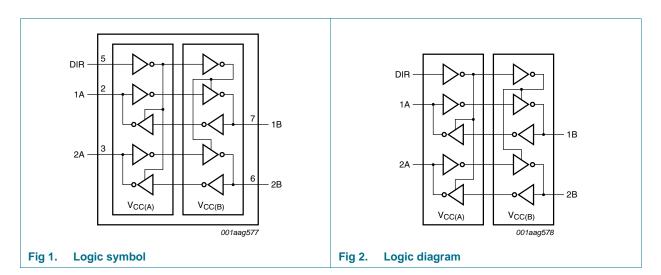
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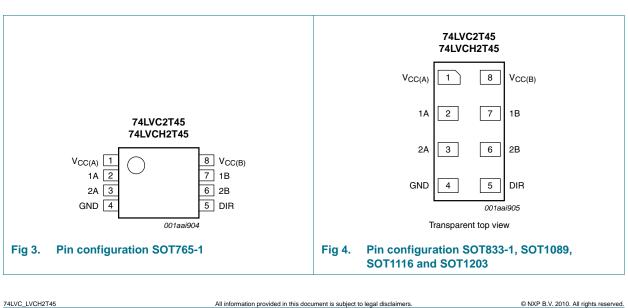
Table 2. Markingcontinued	
Type number	Marking code ^[1]
74LVC2T45GN	V5
74LVCH2T45GN	X5
74LVC2T45GS	V5
74LVCH2T45GS	X5

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



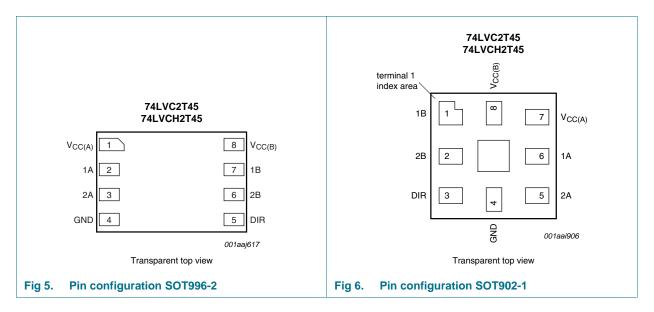
6. Pinning information



6.1 Pinning

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6.2 Pin description

Symbol	Pin		Description	
	SOT765-1, SOT833-1, SOT1089, SOT996-2, SOT1116 and SOT1203	SOT902-1		
V _{CC(A)}	1	7	supply voltage A (port A and DIR)	
1A	2	6	data input or output	
2A	3	5	data input or output	
GND	4	4	ground (0 V)	
DIR	5	3	direction control	
2B	6	2	data input or output	
1B	7	1	data input or output	
/ _{CC(B)}	8	8	supply voltage B (port B)	

7. Functional description

Table 4.Function table

Supply voltage	Input	Input/output ^[2]				
V _{CC(A)} , V _{CC(B)}	DIR	nA	nB			
1.2 V to 5.5 V	L	nA = nB input				
1.2 V to 5.5 V	Н	input	nB = nA			
GND ^[3]	Х	Z	Z			

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

[2] The input circuit of the data I/O is always active.

[3] When either $V_{CC(A)}$ or $V_{CC(B)}$ is at GND level, the device goes into suspend mode.

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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

			•		,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		-0.5	+6.5	V
V _{CC(B)}	supply voltage B		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode	<u>[1][2][3]</u> –0.5	$V_{CCO} + 0.5$	V
		Suspend or 3-state mode	<u>[1]</u> –0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CCO}	[2] _	±50	mA
I _{CC}	supply current	I _{CC(A)} or I _{CC(B)}	-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	<u>[4]</u> _	250	mW

[1] The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] V_{CCO} is the supply voltage associated with the output port.

[3] V_{CCO} + 0.5 V should not exceed 6.5 V.

For VSSOP8 packages: above 110 °C the value of P_{tot} derates linearly with 8.0 mW/K.
 For XSON8, XSON8U and XQFN8U packages: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		1.2	5.5	V
V _{CC(B)}	supply voltage B		1.2	5.5	V
VI	input voltage		0	5.5	V
Vo	output voltage	Active mode	<u>[1]</u> 0	V _{cco}	V
		Suspend or 3-state mode	0	5.5	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V _{CCI} = 1.2 V	[2] _	20	ns/V
		V _{CCI} = 1.4 V to 1.95 V	-	20	ns/V
		V_{CCI} = 2.3 V to 2.7 V	-	20	ns/V
		$V_{CCI} = 3 V \text{ to } 3.6 V$	-	10	ns/V
		V_{CCI} = 4.5 V to 5.5 V	-	5	ns/V

[1] V_{CCO} is the supply voltage associated with the output port.

[2] V_{CCI} is the supply voltage associated with the input port.

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10. Static characteristics

Typical static characteristics at T_{amb} = 25 °C Table 7.

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	M	lin Typ	Мах	Unit
V _{ОН}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = -3 \text{ mA}; V_{CCO} = 1.2 \text{ V}$	<u>[1]</u> -	1.09) -	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 3 \text{ mA}; V_{CCO} = 1.2 \text{ V}$	<u>[1]</u> _	0.07	· -	V
lı	input leakage current	DIR input; $V_I = 0 V$ to 5.5 V; $V_{CCI} = 1.2 V$ to 5.5 V	[2] _	-	±1	μΑ
I _{BHL}	bus hold LOW current	A or B port; V _I = 0.42 V; V _{CCI} = 1.2 V	[2] _	19	-	μΑ
I _{BHH}	bus hold HIGH current	A or B port; V _I = 0.78 V; V _{CCI} = 1.2 V	[2] _	-19	-	μΑ
I _{BHLO}	bus hold LOW overdrive current	A or B port; $V_{CCI} = 1.2 V$	[2][3] _	19	-	μΑ
I _{BHHO}	bus hold HIGH overdrive current	A or B port; $V_{CCI} = 1.2 V$	[2][3] _	–19	-	μΑ
l _{oz}	OFF-state output current	A or B port; $V_0 = 0$ V or V_{CCO} ; $V_{CCO} = 1.2$ V to 5.5 V	<u>[1]</u> _	-	±1	μΑ
I _{OFF}	power-off leakage current	A port; V ₁ or V _O = 0 V to 5.5 V; V _{CC(A)} = 0 V; V _{CC(B)} = 1.2 V to 5.5 V	-	-	±1	μΑ
		B port; V ₁ or V _O = 0 V to 5.5 V; V _{CC(B)} = 0 V; V _{CC(A)} = 1.2 V to 5.5 V	-	-	±1	μΑ
Cı	input capacitance	DIR input; $V_1 = 0 V \text{ or } 3.3 V$; $V_{CC(A)} = V_{CC(B)} = 3.3 V$	-	2.2	-	рF
C _{I/O}	input/output capacitance	A and B port; suspend mode; $V_O = 3.3 \text{ V or } 0 \text{ V}$; $V_{CC(A)} = V_{CC(B)} = 3.3 \text{ V}$	-	6.0	-	pF

[1] $\,\,$ V_{CCO} is the supply voltage associated with the output port.

[2] $\,$ V_{CCI} is the supply voltage associated with the data input port.

[3] To guarantee the node switches, an external driver must source/sink at least I_{BHLO}/I_{BHHO} when the input is in the range V_{IL} to V_{IH} .

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Symbol	Parameter	Conditions		−40 °C t	o +85 °C	–40 °C to +125 °C		
				Min	Max	Min	Max	
/ _{IH}	HIGH-level input voltage	data input	<u>[1]</u>					
		V _{CCI} = 1.2 V		0.8V _{CCI}	-	0.8V _{CCI}	-	V
		$V_{CCI} = 1.4 \text{ V to } 1.95 \text{ V}$		$0.65V_{CCI}$	-	$0.65V_{CCI}$	-	V
		$V_{CCI} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		1.7	-	1.7	-	V
		$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.0	-	2.0	-	V
		$V_{CCI} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$		0.7V _{CCI}	-	0.7V _{CCI}	-	V
		DIR input						
		V _{CCI} = 1.2 V		0.8V _{CC(A)}	-	0.8V _{CC(A)}	-	V
		$V_{CCI} = 1.4 \text{ V to } 1.95 \text{ V}$		0.65V _{CC(A)}	-	0.65V _{CC(A)}	-	V
		$V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$		1.7	-	1.7	-	V
		$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.0	-	2.0	-	V
		$V_{CCI} = 4.5 \text{ V}$ to 5.5 V		0.7V _{CC(A)}	-	0.7V _{CC(A)}	-	V
/ _{IL}	LOW-level input voltage	data input	<u>[1]</u>					
		V _{CCI} = 1.2 V		-	0.2V _{CCI}	-	0.2V _{CCI}	V
		$V_{CCI} = 1.4 \text{ V to } 1.95 \text{ V}$		-	$0.35V_{CCI}$	-	$0.35V_{CCI}$	V
		$V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$		-	0.7	-	0.7	V
		$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	0.8	-	0.8	V
		$V_{CCI} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$		-	0.3V _{CCI}	-	0.3V _{CCI}	V
		DIR input						
		V _{CCI} = 1.2 V		-	0.2V _{CC(A)}	-	0.2V _{CC(A)}	V
		$V_{CCI} = 1.4 \text{ V to } 1.95 \text{ V}$		-	0.35V _{CC(A)}	-	0.35V _{CC(A)}	V
		$V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$		-	0.7	-	0.7	V
		$V_{CCI} = 3.0 V \text{ to } 3.6 V$		-	0.8	-	0.8	V
		$V_{CCI} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$		-	0.3V _{CC(A)}	-	0.3V _{CC(A)}	V
/ _{ОН}	HIGH-level	$V_{I} = V_{IH}$						
	output voltage	$I_{O} = -100 \ \mu\text{A};$ $V_{CCO} = 1.2 \ \text{V} \text{ to } 4.5 \ \text{V}$	[2]	$V_{CCO}-0.1$	-	$V_{CCO}-0.1$	-	V
		$I_{O} = -6 \text{ mA}; V_{CCO} = 1.4 \text{ V}$		1.0	-	1.0	-	V
		$I_{O} = -8 \text{ mA}; V_{CCO} = 1.65 \text{ V}$		1.2	-	1.2	-	V
		$I_{O} = -12 \text{ mA}; V_{CCO} = 2.3 \text{ V}$		1.9	-	1.9	-	V
		$I_{O} = -24 \text{ mA}; V_{CCO} = 3.0 \text{ V}$		2.4	-	2.4	-	V
		$I_0 = -32 \text{ mA}; V_{CCO} = 4.5 \text{ V}$		3.8	-	3.8	-	V

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (around = 0 V).

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Symbol	Parameter	Conditions		−40 °C t	o +85 °C	-40 °C to	o +125 °C	Uni
				Min	Max	Min	Max	
V _{OL}	LOW-level	$V_{I} = V_{IL}$	[2]					
	output voltage	$I_{O} = 100 \ \mu$ A; V _{CCO} = 1.2 V to 4.5 V		-	0.1	-	0.1	V
		$I_0 = 6 \text{ mA}; V_{CCO} = 1.4 \text{ V}$		-	0.3	-	0.3	V
		$I_0 = 8 \text{ mA}; V_{CCO} = 1.65 \text{ V}$		-	0.45	-	0.45	V
		$I_0 = 12 \text{ mA}; V_{CCO} = 2.3 \text{ V}$		-	0.3	-	0.3	V
		$I_0 = 24 \text{ mA}; V_{CCO} = 3.0 \text{ V}$		-	0.55	-	0.55	V
		$I_0 = 32 \text{ mA}; V_{CCO} = 4.5 \text{ V}$		-	0.55	-	0.55	V
I	input leakage current	DIR input; $V_I = 0 V$ to 5.5 V; $V_{CCI} = 1.2 V$ to 5.5 V		-	±2	-	±10	μA
I _{BHL}	bus hold LOW	A or B port	<u>[1]</u>					
	current	$V_{I} = 0.49 \text{ V}; V_{CCI} = 1.4 \text{ V}$		15	-	10	-	μA
		$V_{I} = 0.58 \text{ V}; V_{CCI} = 1.65 \text{ V}$		25	-	20	-	μA
		$V_{I} = 0.70 \text{ V}; V_{CCI} = 2.3 \text{ V}$		45	-	45	-	μA
		$V_{I} = 0.80 \text{ V}; V_{CCI} = 3.0 \text{ V}$		100	-	80	-	μA
		$V_{I} = 1.35 \text{ V}; V_{CCI} = 4.5 \text{ V}$		100	-	100	-	μΑ
BHH	bus hold HIGH current	A or B port	<u>[1]</u>					
		$V_{I} = 0.91 \text{ V}; V_{CCI} = 1.4 \text{ V}$		-15	-	-10	-	μA
		$V_{I} = 1.07 \text{ V}; V_{CCI} = 1.65 \text{ V}$		-25	-	-20	-	μA
		$V_{I} = 1.60 \text{ V}; V_{CCI} = 2.3 \text{ V}$		-45	-	-45	-	μA
		$V_{I} = 2.00 \text{ V}; V_{CCI} = 3.0 \text{ V}$		-100	-	-80	-	μΑ
		$V_{I} = 3.15 \text{ V}; V_{CCI} = 4.5 \text{ V}$		-100	-	-100	-	μA
BHLO	bus hold LOW	A or B port	<u>[1][3]</u>					
	overdrive current	$V_{CCI} = 1.6 V$		125	-	125	-	μA
	ourrent	V _{CCI} = 1.95 V		200	-	200	-	μA
		$V_{CCI} = 2.7 V$		300	-	300	-	μA
		V _{CCI} = 3.6 V		500	-	500	-	μA
		$V_{CCI} = 5.5 V$		900	-	900	-	μA
внно	bus hold HIGH	A or B port	<u>[1][3]</u>					
	overdrive current	$V_{CCI} = 1.6 V$		-125	-	-125	-	μA
	ourront	V _{CCI} = 1.95 V		-200	-	-200	-	μA
		$V_{CCI} = 2.7 V$		-300	-	-300	-	μA
		$V_{CCI} = 3.6 V$		-500	-	-500	-	μA
		$V_{CCI} = 5.5 V$		-900	-	-900	-	μA
OZ	OFF-state output current	A or B port; $V_0 = 0$ V or V_{CCO} ; $V_{CCO} = 1.2$ V to 5.5 V	[2]	-	±2	-	±10	μA

Table 8. Static characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

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Symbol	Parameter	Conditions		-40 °C t	to +85 °C	-40 °C to	o +125 °C	Unit
				Min	Max	Min	Max	
I _{OFF}	power-off leakage current	A port; V ₁ or V ₀ = 0 V to 5.5 V; V _{CC(A)} = 0 V; V _{CC(B)} = 1.2 V to 5.5 V	·	-	±2	-	±10	μA
		B port; V ₁ or V _O = 0 V to 5.5 V; V _{CC(B)} = 0 V; V _{CC(A)} = 1.2 V to 5.5 V		-	±2	-	±10	μA
I _{CC}	supply current	A port; $V_I = 0$ V or V_{CCI} ; $I_O = 0$ A	<u>[1]</u>					
		$V_{CC(A)}$, $V_{CC(B)} = 1.2$ V to 5.5 V		-	8	-	8	μΑ
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.65 V to 5.5 V		-	3	-	3	μA
		$V_{CC(A)} = 5.5 \text{ V}; V_{CC(B)} = 0 \text{ V}$		-	2	-	2	μA
		$V_{CC(A)} = 0 V; V_{CC(B)} = 5.5 V$		-2	-	-2	-	μA
		B port; $V_I = 0$ V or V_{CCI} ; $I_O = 0$ A						
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.2 V to 5.5 V		-	8	-	8	μA
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.65 V to 5.5 V		-	3	-	3	μA
		$V_{CC(B)} = 0 V; V_{CC(A)} = 5.5 V$		-2	-	-2	-	μA
		$V_{CC(B)} = 5.5 \text{ V}; V_{CC(A)} = 0 \text{ V}$		-	2	-	2	μA
		A plus B port ($I_{CC(A)} + I_{CC(B)}$); $I_O = 0$ A; $V_I = 0$ V or V_{CCI}						
		$V_{CC(A)}$, $V_{CC(B)} = 1.2$ V to 5.5 V		-	16	-	16	μA
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.65 V to 5.5 V		-	4	-	4	μA
∆l _{CC}	additional supply current	per input; $V_{CC(A)}$, $V_{CC(B)}$ = 3.0 V to 5.5 V						
		A port; A port at $V_{CC(A)} - 0.6$ V; DIR at $V_{CC(A)}$; B port = open	<u>[4]</u>	-	50	-	75	μΑ
		DIR input; DIR at $V_{CC(A)} - 0.6$ V; A port at $V_{CC(A)}$ or GND; B port = open		-	50	-	75	μA
		B port; B port at $V_{CC(B)} - 0.6 V$; DIR at GND; A port = open	[4]	-	50	-	75	μA

Table 8. Static characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] V_{CCO} is the supply voltage associated with the output port.

[3] To guarantee the node switches, an external driver must source/sink at least I_{BHLO}/I_{BHHO} when the input is in the range V_{IL} to V_{IH}.

[4] For non bus hold parts only (74LVC2T45).

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11. Dynamic characteristics

Table 9.Typical dynamic characteristics at $V_{CC(A)} = 1.2$ V and $T_{amb} = 25$ °CVoltages are referenced to GND (ground = 0 V); for test circuit see Figure 9; for waveforms see Figure 7 and Figure 8.

Symbol	Parameter	Conditions	V _{CC(B)}						Unit
			1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t _{PLH}	LOW to HIGH	A to B	10.6	8.1	7.0	5.8	5.3	5.1	ns
	propagation delay	B to A	10.6	9.5	9.0	8.5	8.3	8.2	ns
t _{PHL}	HIGH to LOW	A to B	10.1	7.1	6.0	5.3	5.2	5.4	ns
	propagation delay	B to A	10.1	8.6	8.1	7.8	7.6	7.6	ns
t _{PHZ}	HIGH to OFF-state propagation delay	DIR to A	9.4	9.4	9.4	9.4	9.4	9.4	ns
		DIR to B	12.0	9.4	9.0	7.8	8.4	7.9	ns
t _{PLZ}	LOW to OFF-state	DIR to A	7.1	7.1	7.1	7.1	7.1	7.1	ns
	propagation delay	DIR to B	9.5	7.8	7.7	6.9	7.6	7.0	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	20.1	17.3	16.7	15.4	15.9	15.2	ns
	propagation delay	DIR to B [1]	17.7	15.2	14.1	12.9	12.4	12.2	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	22.1	18.0	17.1	15.6	16.0	15.5	ns
	propagation delay	DIR to B [1]	19.5	16.5	15.4	14.7	14.6	14.8	ns

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times".

Table 10. Typical dynamic characteristics at $V_{CC(B)}$ = 1.2 V and T_{amb} = 25 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9; for waveforms see Figure 7 and Figure 8.

	,								
Symbol	Parameter	Conditions			Vco	C(A)			Unit
			1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t _{PLH}	LOW to HIGH	A to B	10.6	9.5	9.0	8.5	8.3	8.2	ns
	propagation delay	B to A	10.6	8.1	7.0	5.8	5.3	5.1	ns
t _{PHL}	HIGH to LOW	A to B	10.1	8.6	8.1	7.8	7.6	7.6	ns
	propagation delay	B to A	10.1	7.1	6.0	5.3	5.2	5.4	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	9.4	6.5	5.7	4.1	4.1	3.0	ns
	propagation delay	DIR to B	12.0	6.1	5.4	4.6	4.3	4.0	ns
t _{PLZ}	LOW to OFF-state	DIR to A	7.1	4.9	4.5	3.2	3.4	2.5	ns
	propagation delay	DIR to B	9.5	7.3	6.6	5.9	5.7	5.6	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	20.1	15.4	13.6	11.7	11.0	10.7	ns
	propagation delay	DIR to B [1]	17.7	14.4	13.5	11.7	11.7	10.7	ns
t _{PZL}	OFF-state to LOW propagation delay	DIR to A [1]	22.1	13.2	11.4	9.9	9.5	9.4	ns
		DIR to B [1]	19.5	15.1	13.8	11.9	11.7	10.6	ns

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times".

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Symbol	Parameter	Conditions	$V_{CC(A)}$ and $V_{CC(B)}$							
			1.8 V	2.5 V	3.3 V	5.0 V				
C _{PD}	power dissipation capacitance	A port: (direction A to B); B port: (direction B to A)	2	3	3	4	pF			
		A port: (direction B to A); B port: (direction A to B)	15	16	16	18	pF			

Table 11. Typical power dissipation capacitance at $V_{CC(A)} = V_{CC(B)}$ and $T_{amb} = 25 \ ^{\circ}C \ ^{(1)[2]}$ Voltages are referenced to GND (ground = 0 V).

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 $f_i = input frequency in MHz;$

f_o = output frequency in MHz;

 C_L = load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o) = \text{sum of the outputs.}$

Table 12. Dynamic characteristics for temperature range –40 °C to +85 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9; for wave forms see Figure 7 and Figure 8.

Symbol	Parameter	Conditions					Vcc	С(В)					Unit
			1.5 V :	± 0.1 V	1.8 V ±	0.15 V	2.5 V :	± 0.2 V	3.3 V :	± 0.3 V	5.0 V :	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
$V_{CC(A)} =$	1.4 V to 1.6 V												
t _{PLH}	LOW to HIGH	A to B	2.8	21.3	2.4	17.6	2.0	13.5	1.7	11.8	1.6	10.5	ns
	propagation delay	B to A	2.8	21.3	2.6	19.1	2.3	14.9	2.3	12.4	2.2	12.0	ns
t _{PHL}	HIGH to LOW	A to B	2.6	19.3	2.2	15.3	1.8	11.8	1.7	10.9	1.7	10.8	ns
	propagation delay	B to A	2.6	19.3	2.4	17.3	2.3	13.2	2.2	11.3	2.3	11.0	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	3.0	18.7	3.0	18.7	3.0	18.7	3.0	18.7	3.0	18.7	ns
	propagation delay	DIR to B	3.5	24.8	3.5	23.6	3.0	11.0	3.3	11.3	2.8	10.3	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.4	11.4	2.4	11.4	2.4	11.4	2.4	11.4	2.4	11.4	ns
	propagation delay	DIR to B	2.8	18.3	3.0	17.2	2.5	9.4	3.0	10.1	2.5	9.4	ns
t _{PZH}	H OFF-state to HIGH propagation delay	DIR to A [1]	-	39.6	-	36.3	-	24.3	-	22.5	-	21.4	ns
		DIR to B [1]	-	32.7	-	29.0	-	24.9	-	23.2	-	21.9	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	-	44.1	-	40.9	-	24.2	-	22.6	-	21.3	ns
	propagation delay	DIR to B [1]	-	38.0	-	34.0	-	30.5	-	29.6	-	29.5	ns
V _{CC(A)} =	1.65 V to 1.95 V												
t _{PLH}	LOW to HIGH	A to B	2.6	19.1	2.2	17.7	2.2	9.3	1.7	7.2	1.4	6.8	ns
	propagation delay	B to A	2.4	17.6	2.2	17.7	2.3	16.0	2.1	15.5	1.9	15.1	ns
t _{PHL}	HIGH to LOW	A to B	2.4	17.3	2.0	14.3	1.6	8.5	1.8	7.1	1.7	7.0	ns
	propagation delay	B to A	2.2	15.3	2.0	14.3	2.1	12.9	2.0	12.6	1.8	12.2	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	2.9	17.1	2.9	17.1	2.9	17.1	2.9	17.1	2.9	17.1	ns
	propagation delay	DIR to B	3.2	24.1	3.2	21.9	2.7	11.5	3.0	10.3	2.5	8.2	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.4	10.5	2.4	10.5	2.4	10.5	2.4	10.5	2.4	10.5	ns
	propagation delay	DIR to B	2.5	17.6	2.6	16.0	2.2	9.2	2.7	8.4	2.4	7.1	ns
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Symbol	Parameter	Condition	ns					Vcc	C(B)					Unit
-				1.5 V	± 0.1 V	1.8 V ±	0.15 V	1	± 0.2 V	3.3 V	± 0.3 V	5.0 V :	± 0.5 V	-
				Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
t _{PZH}	OFF-state to HIGH	DIR to A	[1]	-	35.2	-	33.7	-	25.2	-	23.9	-	22.2	ns
	propagation delay	DIR to B	[1]	-	29.6	-	28.2	-	19.8	-	17.7	-	17.3	ns
t _{PZL}	OFF-state to LOW	DIR to A	[1]	-	39.4	-	36.2	-	24.4	-	22.9	-	20.4	ns
	propagation delay	DIR to B	[1]	-	34.4	-	31.4	-	25.6	-	24.2	-	24.1	ns
$V_{CC(A)} = 1$	2.3 V to 2.7 V													
t _{PLH}	LOW to HIGH	A to B		2.3	17.9	2.3	16.0	1.5	8.5	1.3	6.2	1.1	4.8	ns
	propagation delay	B to A		2.0	13.5	2.2	9.3	1.5	8.5	1.4	8.0	1.0	7.5	ns
t _{PHL}	HIGH to LOW	A to B		2.3	15.8	2.1	12.9	1.4	7.5	1.3	5.4	0.9	4.6	ns
	propagation delay	B to A		1.8	11.8	1.9	8.5	1.4	7.5	1.3	7.0	0.9	6.2	ns
t _{PHZ}	HIGH to OFF-state	DIR to A		2.1	8.1	2.1	8.1	2.1	8.1	2.1	8.1	2.1	8.1	ns
	propagation delay	DIR to B		3.0	22.5	3.0	21.4	2.5	11.0	2.8	9.3	2.3	6.9	ns
t _{PLZ}	LOW to OFF-state	DIR to A		1.7	5.8	1.7	5.8	1.7	5.8	1.7	5.8	1.7	5.8	ns
	propagation delay	DIR to B		2.3	14.6	2.5	13.2	2.0	9.0	2.5	8.4	1.8	5.8	ns
t _{PZH}	OFF-state to HIGH	DIR to A	[1]	-	28.1	-	22.5	-	17.5	-	16.4	-	13.3	ns
	propagation delay	DIR to B	[1]	-	23.7	-	21.8	-	14.3	-	12.0	-	10.6	ns
t _{PZL}	OFF-state to LOW	DIR to A	[1]	-	34.3	-	29.9	-	18.5	-	16.3	-	13.1	ns
	propagation delay	DIR to B	[1]	-	23.9	-	21.0	-	15.6	-	13.5	-	12.7	ns
$V_{CC(A)} = $	3.0 V to 3.6 V													
t _{PLH}	LOW to HIGH	A to B		2.3	17.1	2.1	15.5	1.4	8.0	0.8	5.6	0.7	4.4	ns
	propagation delay	B to A		1.7	11.8	1.7	7.2	1.3	6.2	0.7	5.6	0.6	5.4	ns
t _{PHL}	HIGH to LOW	A to B		2.2	15.6	2.0	12.6	1.3	7.0	0.8	5.0	0.7	4.0	ns
	propagation delay	B to A		1.7	10.9	1.8	7.1	1.3	5.4	0.8	5.0	0.7	4.5	ns
t _{PHZ}	HIGH to OFF-state	DIR to A		2.3	7.3	2.3	7.3	2.3	7.3	2.3	7.3	2.7	7.3	ns
	propagation delay	DIR to B		2.9	18.0	2.9	16.5	2.3	10.1	2.7	8.6	2.2	6.3	ns
t _{PLZ}	LOW to OFF-state	DIR to A		2.0	5.6	2.0	5.6	2.0	5.6	2.0	5.6	2.0	5.6	ns
	propagation delay	DIR to B		2.3	13.6	2.4	12.5	1.9	7.8	2.3	7.1	1.7	4.9	ns
t _{PZH}	OFF-state to HIGH	DIR to A	[1]	-	25.4	-	19.7	-	14.0	-	12.7	-	10.3	ns
	propagation delay	DIR to B	[1]	-	22.7	-	21.1	-	13.6	-	11.2	-	10.0	ns
t _{PZL}	OFF-state to LOW	DIR to A	[1]	-	28.9	-	23.6	-	15.5	-	13.6	-	10.8	ns
	propagation delay	DIR to B	[1]	-	22.9	-	19.9	-	14.3	-	12.3	-	11.3	ns
$V_{CC(A)} = $	4.5 V to 5.5 V													
t _{PLH}	LOW to HIGH	A to B		2.2	16.6	1.9	15.1	1.0	7.5	0.7	5.4	0.5	3.9	ns
	propagation delay	B to A		1.6	10.5	1.4	6.8	1.0	4.8	0.7	4.4	0.5	3.9	ns
t _{PHL}	HIGH to LOW	A to B		2.3	15.3	1.8	12.2	1.0	6.2	0.7	4.5	0.5	3.5	ns
	propagation delay	B to A		1.7	10.8	1.7	7.0	0.9	4.6	0.7	4.0	0.5	3.5	ns
t _{PHZ}	HIGH to OFF-state	DIR to A		1.7	5.4	1.7	5.4	1.7	5.4	1.7	5.4	1.7	5.4	ns
	propagation delay	DIR to B		2.9	17.3	2.9	16.1	2.3	9.7	2.7	8.0	2.5	5.7	ns

Table 12. Dynamic characteristics for temperature range $-40 \degree$ C to $+85 \degree$ C ... continued Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9; for wave forms see Figure 7 and Figure 8.

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Symbol	Parameter	Conditions					Vcc	(B)					Unit
			1.5 V ±	0.1 V	1.8 V \pm	0.15 V	2.5 V ±	0.2 V	3.3 V \pm 0.3 V		5.0 V \pm 0.5 V		
			Min	Max	Min	Max	Min	Max	Min	Мах	Min	Max	1
t _{PLZ}	LOW to OFF-state	DIR to A	1.4	3.7	1.4	3.7	1.3	3.7	1.0	3.7	0.9	3.7	ns
	propagation delay	DIR to B	2.3	13.1	2.4	12.1	1.9	7.4	2.3	7.0	1.8	4.5	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	23.6	-	18.9	-	12.2	-	11.4	-	8.4	ns
	propagation delay	DIR to B [1]	-	20.3	-	18.8	-	11.2	-	9.1	-	7.6	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	-	28.1	-	23.1	-	14.3	-	12.0	-	9.2	ns
propagation delay		DIR to B [1]	-	20.7	-	17.6	-	11.6	-	9.9	-	8.9	ns

Table 12. Dynamic characteristics for temperature range -40 °C to +85 °C ... continued

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times".

Table 13. Dynamic characteristics for temperature range –40 °C to +125 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9; for wave forms see Figure 7 and Figure 8.

Symbol	Parameter	Conditions					٧ _{cc}	с(В)					Unit
			1.5 V ±	± 0.1 V	1.8 V ±	0.15 V	2.5 V :	± 0.2 V	3.3 V :	± 0.3 V	5.0 V ±	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
V _{CC(A)} =	1.4 V to 1.6 V												
t _{PLH}	LOW to HIGH	A to B	2.5	23.5	2.1	19.4	1.8	14.9	1.5	13.0	1.4	11.6	ns
	propagation delay	B to A	2.5	23.5	2.3	21.1	2.0	16.4	2.0	13.7	1.9	13.2	ns
t _{PHL}	HIGH to LOW	A to B	2.3	21.3	1.9	16.9	1.6	13.0	1.5	12.0	1.5	11.9	ns
	propagation delay	B to A	2.3	21.3	2.1	19.1	2.0	14.6	1.9	12.5	2.0	12.1	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	2.7	20.6	2.7	20.6	2.7	20.6	2.7	20.6	2.7	20.6	ns
	propagation delay	DIR to B	3.1	27.3	3.1	26.0	2.7	12.1	2.9	12.5	2.5	11.4	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.1	12.6	2.1	12.6	2.1	12.6	2.1	12.6	2.1	12.6	ns
	propagation delay	DIR to B	2.5	20.2	2.7	19.0	2.2	10.4	2.7	11.2	2.2	10.4	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	43.7	-	40.1	-	26.8	-	24.9	-	23.6	ns
	propagation delay	DIR to B [1]	-	36.1	-	32.0	-	27.5	-	25.6	-	24.2	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	-	48.6	-	45.1	-	26.7	-	25.0	-	23.5	ns
	propagation delay	DIR to B [1]	-	41.9	-	37.5	-	33.6	-	32.6	-	32.5	ns
$V_{CC(A)} =$	1.65 V to 1.95 V												
t _{PLH}	LOW to HIGH	A to B	2.3	21.1	1.9	19.5	1.9	10.3	1.5	8.0	1.2	7.5	ns
	propagation delay	B to A	2.1	19.4	1.9	19.5	2.0	17.6	1.8	17.1	1.7	16.7	ns
t _{PHL}	HIGH to LOW	A to B	2.1	19.1	1.8	15.8	1.4	9.4	1.6	7.9	1.5	7.7	ns
	propagation delay	B to A	1.9	16.9	1.8	15.8	1.8	14.2	1.8	13.9	1.6	13.5	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	2.6	18.9	2.6	18.9	2.6	18.9	2.6	18.9	2.6	18.9	ns
	propagation delay	DIR to B	2.8	26.6	2.8	24.1	2.4	12.7	2.7	11.4	2.2	9.1	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.1	11.6	2.1	11.6	2.1	11.6	2.1	11.6	2.1	11.6	ns
	propagation delay	DIR to B	2.2	19.4	2.3	17.6	1.9	10.2	2.4	9.3	2.1	7.9	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	38.8	-	37.1	-	27.8	-	26.4	-	24.6	ns
	propagation delay	DIR to B [1]	-	32.7	-	31.1	-	21.9	-	19.6	-	19.1	ns

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Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 9</u> ; for wave forms see <u>Figure 7</u> and <u>Figure 8</u> .														
Symbol	Parameter	Condition	าร					٧ _{cc}	C(B)					Unit
				1.5 V	± 0.1 V	1.8 V ±	0.15 V	2.5 V :	± 0.2 V	3.3 V :	± 0.3 V	5.0 V :	± 0.5 V	
				Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
t _{PZL}	OFF-state to LOW	DIR to A	[1]	-	43.5	-	39.9	-	26.9	-	25.3	-	22.6	ns
	propagation delay	DIR to B	[1]	-	38.0	-	34.7	-	28.3	-	26.8	-	26.6	ns
$V_{CC(A)} =$	2.3 V to 2.7 V													
t _{PLH}	LOW to HIGH	A to B		2.0	19.7	2.0	17.6	1.3	9.4	1.1	6.9	0.9	5.3	ns
	propagation delay	B to A		1.8	14.9	1.9	10.3	1.3	9.4	1.2	8.8	0.9	8.3	ns
t _{PHL}	HIGH to LOW	A to B		2.0	17.4	1.8	14.2	1.2	8.3	1.1	6.0	0.8	5.1	ns
	propagation delay	B to A		1.6	13.0	1.7	9.4	1.2	8.3	1.1	7.7	0.8	6.9	ns
t _{PHZ}	HIGH to OFF-state	DIR to A		1.8	9.0	1.8	9.0	1.8	9.0	1.8	9.0	1.8	9.0	ns
	propagation delay	DIR to B		2.7	24.8	2.7	23.6	2.2	12.1	2.5	10.3	2.0	7.6	ns
t _{PLZ}	LOW to OFF-state	DIR to A		1.5	6.4	1.5	6.4	1.5	6.4	1.5	6.4	1.5	6.4	ns
	propagation delay	DIR to B		2.0	16.1	2.2	14.6	1.8	9.9	2.2	9.3	1.6	6.4	ns
t _{PZH}	OFF-state to HIGH	DIR to A	[1]	-	31.0	-	24.9	-	19.3	-	18.1	-	14.7	ns
	propagation delay	DIR to B	[1]	-	26.1	-	24.0	-	15.8	-	13.3	-	11.7	ns
t _{PZL}	OFF-state to LOW	DIR to A	[1]	-	37.8	-	33.0	-	20.4	-	18.0	-	14.5	ns
	propagation delay	DIR to B	[1]	-	26.4	-	23.2	-	17.3	-	15.0	-	14.1	ns
$V_{CC(A)} =$	3.0 V to 3.6 V													
t _{PLH}	LOW to HIGH	A to B		2.0	18.9	1.8	17.1	1.2	8.8	0.7	6.2	0.6	4.9	ns
	propagation delay	B to A		1.5	13.0	1.5	8.0	1.1	6.9	0.6	6.2	0.5	6.0	ns
t _{PHL}	HIGH to LOW	A to B		1.9	17.2	1.8	13.9	1.1	7.7	0.7	5.5	0.6	4.4	ns
	propagation delay	B to A		1.5	12.0	1.6	7.9	1.1	6.0	0.7	5.5	0.6	5.0	ns
t _{PHZ}	HIGH to OFF-state	DIR to A		2.0	8.1	2.0	8.1	2.0	8.1	2.0	8.1	2.4	8.1	ns
	propagation delay	DIR to B		2.6	19.8	2.6	18.2	2.0	11.2	2.4	9.5	1.9	7.0	ns
t _{PLZ}	LOW to OFF-state	DIR to A		1.8	6.2	1.8	6.2	1.8	6.2	1.8	6.2	1.8	6.2	ns
	propagation delay	DIR to B		2.0	15.0	2.1	13.8	1.7	8.6	2.0	7.9	1.5	5.4	ns
t _{PZH}	OFF-state to HIGH propagation delay	DIR to A	[1]	-	28.0	-	21.8	-	15.5	-	14.1	-	11.4	ns
		DIR to B	[1]	-	25.1	-	23.3	-	15.0	-	12.4	-	11.1	ns
t _{PZL}	OFF-state to LOW propagation delay	DIR to A	[1]	-	31.8	-	26.1	-	17.2	-	15.0	-	12.0	ns
		DIR to B	[1]	-	25.3	-	22.0	-	15.8	-	13.6	-	12.5	ns
	4.5 V to 5.5 V													
t _{PLH}	LOW to HIGH propagation delay	A to B		1.9	18.3	1.7	16.7	0.9	8.3	0.6	6.0	0.4	4.3	ns
		B to A		1.4	11.6	1.2	7.5	0.9	5.3	0.6	4.9	0.4	4.3	ns
t _{PHL}	HIGH to LOW propagation delay	A to B		2.0	16.9	1.6	13.5	0.9	6.9	0.6	5.0	0.4	3.9	ns
		B to A		1.5	11.9	1.5	7.7	0.8	5.1	0.6	4.4	0.4	3.9	ns
t _{PHZ}	HIGH to OFF-state	DIR to A		1.5	6.0	1.5	6.0	1.5	6.0	1.5	6.0	1.5	6.0	ns
	propagation delay	DIR to B		2.6	19.1	2.6	17.8	2.0	10.7	2.4	8.8	2.2	6.3	ns
t _{PLZ}	LOW to OFF-state	DIR to A		1.2	4.1	1.2	4.1	1.1	4.1	0.9	4.1	0.8	4.1	ns
	propagation delay	DIR to B		2.0	14.5	2.1	13.4	1.7	8.2	2.0	7.7	1.6	5.0	ns

 Table 13. Dynamic characteristics for temperature range -40 °C to +125 °C ...continued

 Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9; for wave forms see Figure 7 and Figure 8.

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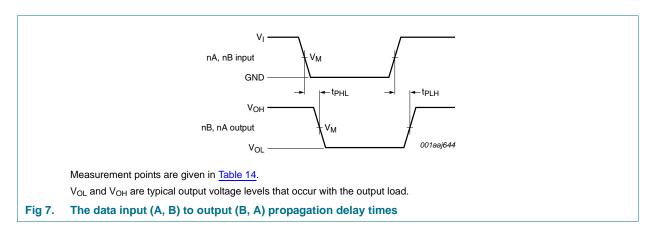
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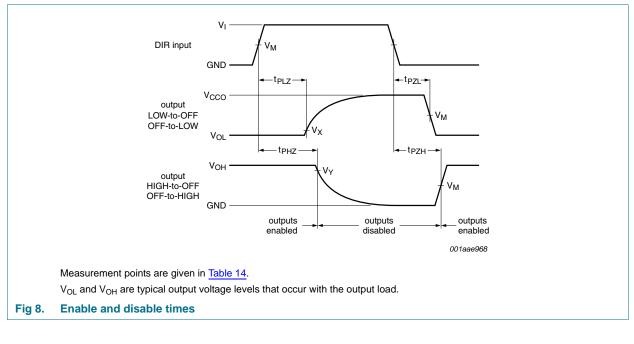
	are referenced to GN				•					Figure	<mark>7</mark> and <mark>F</mark>	igure 8.	
Symbol	Parameter	Conditions					Vcc	С(В)					Unit
			1.5 V :	± 0.1 V	1.8 V ±	0.15 V	2.5 V :	± 0.2 V	3.3 V :	± 0.3 V	5.0 V :	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
t _{PZH}	OFF-state to HIGH	DIR to A	-	26.1	-	20.9	-	13.5	-	12.6	-	9.3	ns
	propagation delay	DIR to B	-	22.4	-	20.8	-	12.4	-	10.1	-	8.4	ns
t _{PZL}	OFF-state to LOW	DIR to A	-	31.0	-	25.5	-	15.8	-	13.2	-	10.2	ns
propagation delay		DIR to B	_	22.9	-	19.5	-	12.9	-	11.0	-	9.9	ns

Dynamic characteristics for temperature range -40 °C to +125 °C ... continued Table 13

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times".

12. Waveforms





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Table 14. Measurement points											
Supply voltage	Input ^[1]	Output ^[2]									
V _{CC(A)} , V _{CC(B)}	V _M	V _M	V _X	V _Y							
1.2 V to 1.6 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.1 V	V _{OH} – 0.1 V							
1.65 V to 2.7 V	0.5V _{CCI}	$0.5V_{CCO}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V							
3.0 V to 5.5 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.3 V	V _{OH} – 0.3 V							

Table 14. Measurement points

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] V_{CCO} is the supply voltage associated with the output port.

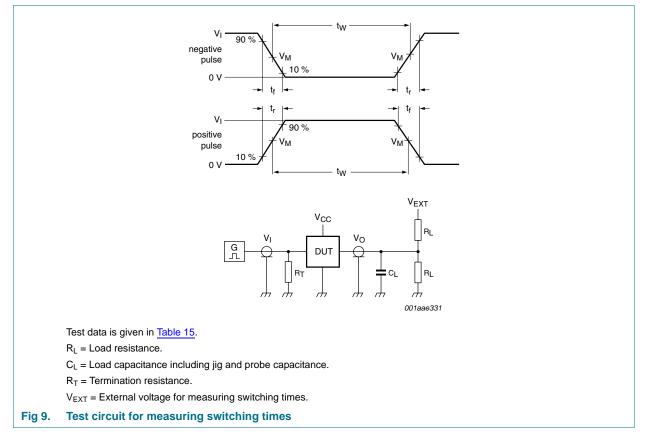


Table 15. Test data

Supply voltage	Input		Load		V _{EXT}		
V _{CC(A)} , V _{CC(B)}	V <mark>[^[1]</mark>	∆ t/∆V[2]	CL	RL	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ} [3]
1.2 V to 5.5 V	V _{CCI}	\leq 1.0 ns/V	15 pF	2 kΩ	open	GND	2V _{CCO}

[1] V_{CCI} is the supply voltage associated with the data input port.

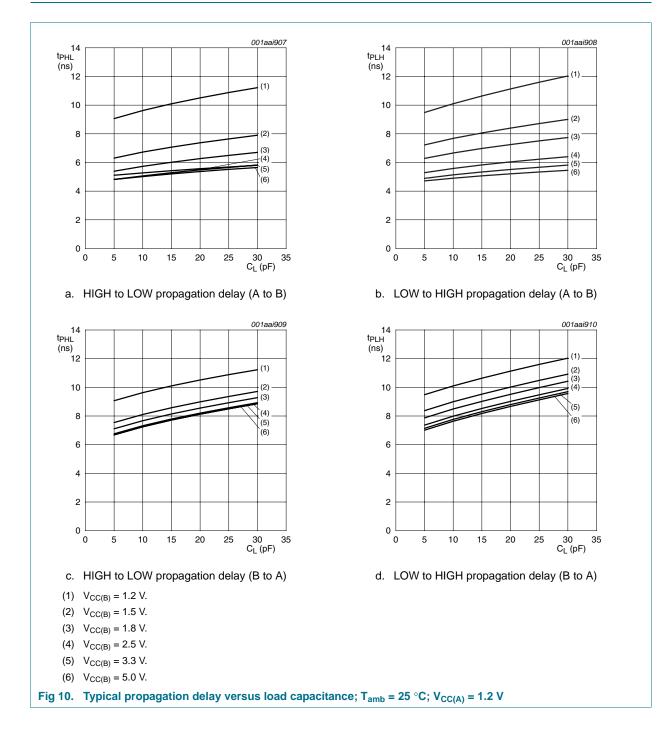
[2] $dV/dt \ge 1.0$ V/ns.

[3] V_{CCO} is the supply voltage associated with the output port.

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13. Typical propagation delay characteristics

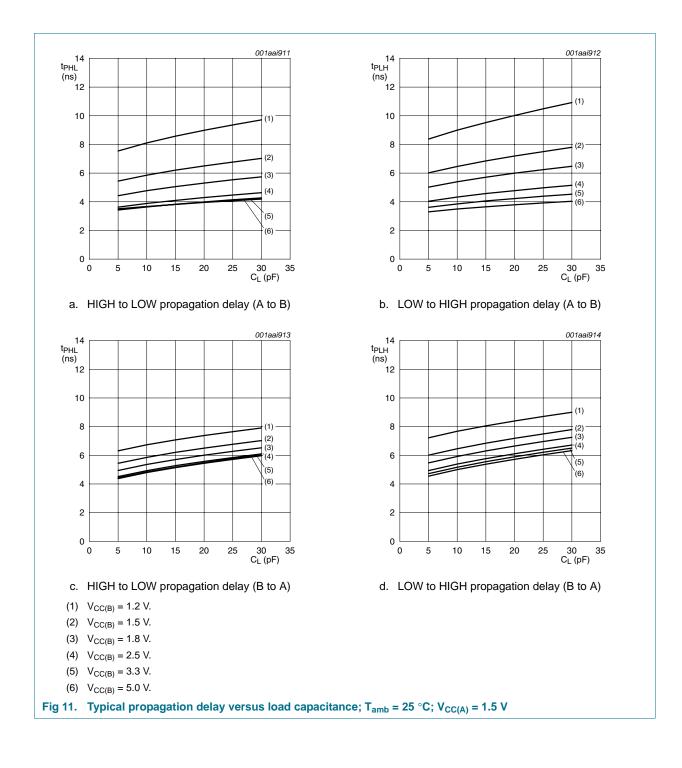
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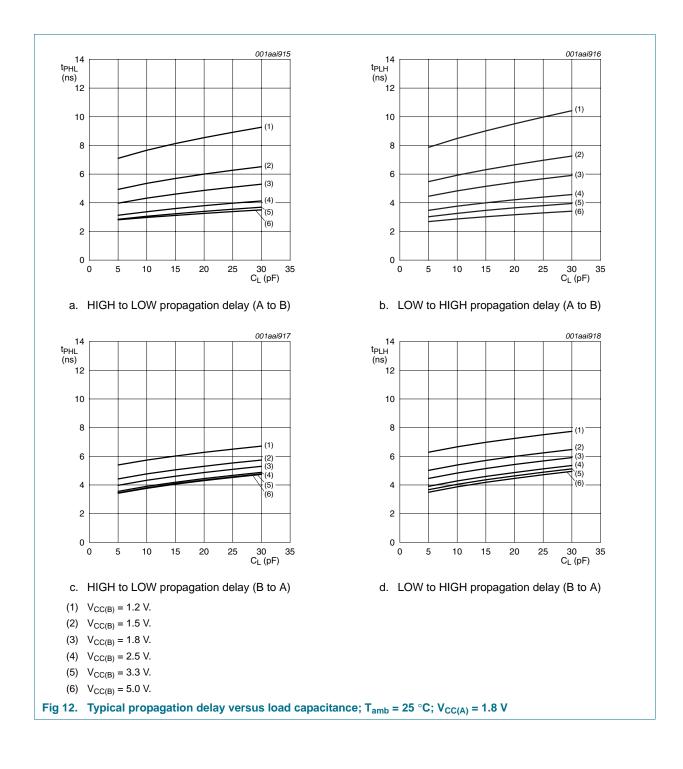
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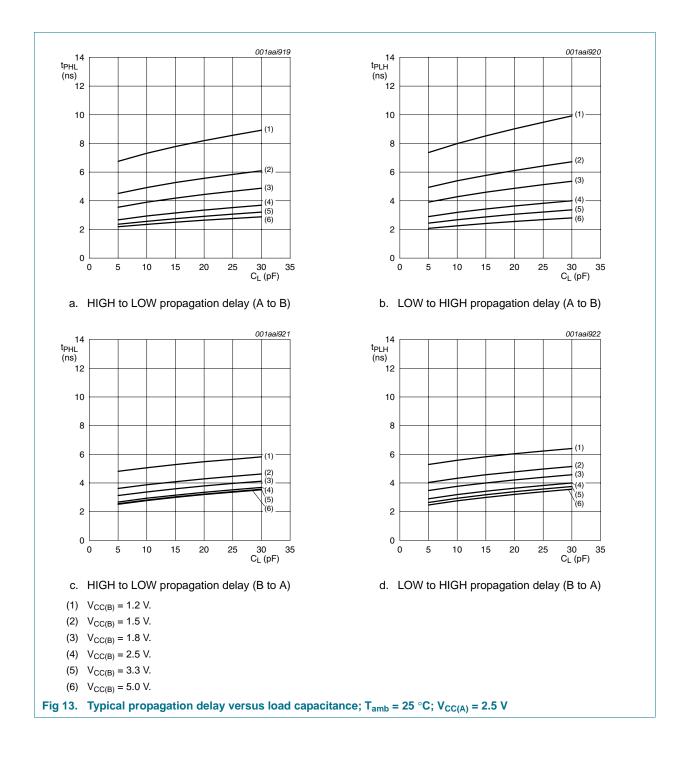


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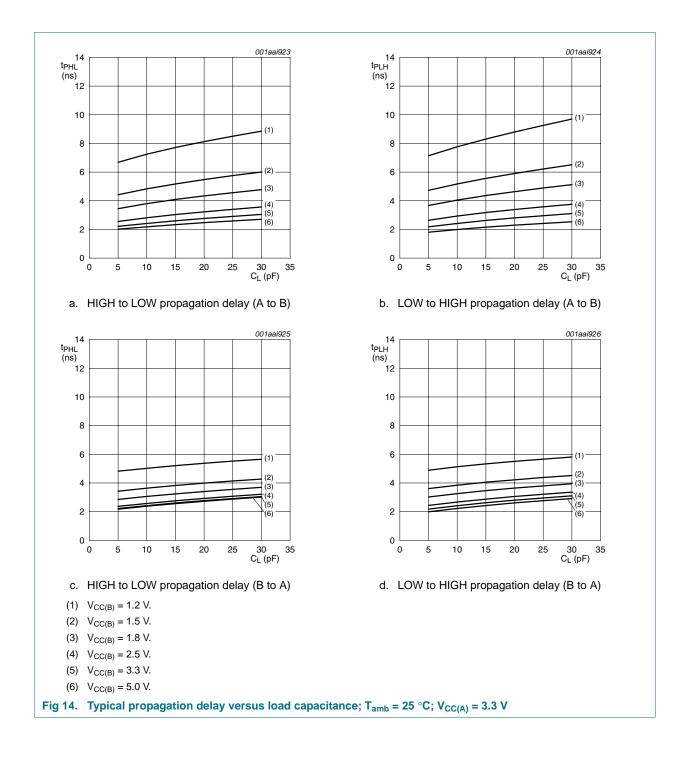
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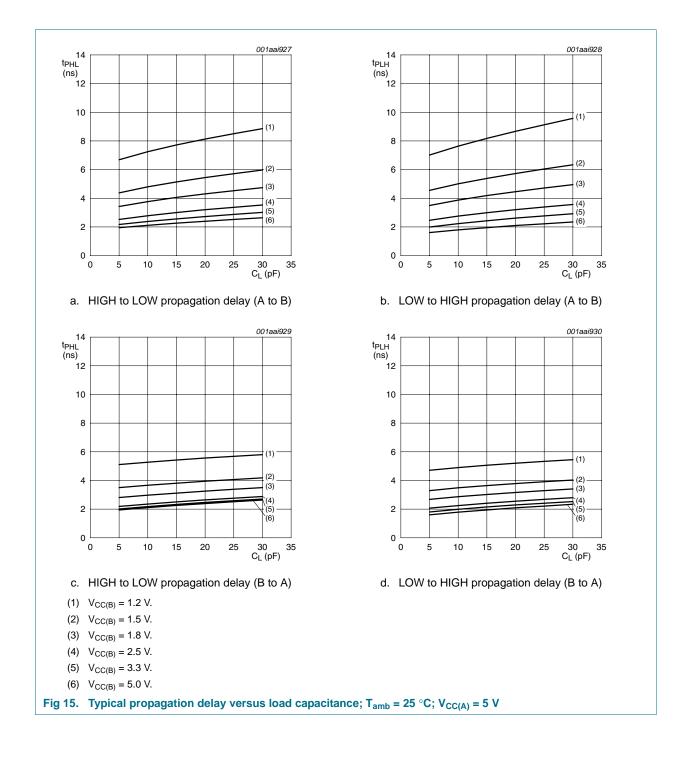
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14. Application information

14.1 Unidirectional logic level-shifting application

The circuit given in <u>Figure 16</u> is an example of the 74LVC2T45; 74LVCH2T45 being used in an unidirectional logic level-shifting application.

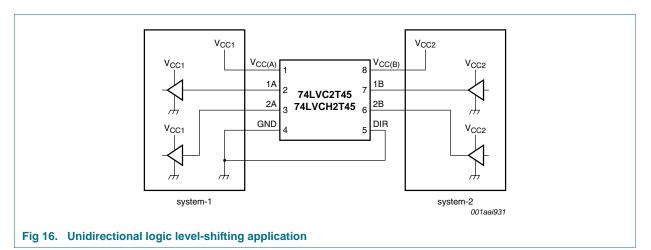


Table To.	Description of undirectional logic level-smitting application				
Pin	Name	Function	Description		
1	V _{CC(A)}	V _{CC1}	supply voltage of system-1 (1.2 V to 5.5 V)		
2	1A	OUT	output level depends on V _{CC1} voltage		
3	2A	OUT	output level depends on V _{CC1} voltage		
4	GND	GND	device GND		
5	DIR	DIR	the GND (LOW level) determines B port to A port direction		
6	2B	IN	input threshold value depends on V_{CC2} voltage		
7	1B	IN	input threshold value depends on V_{CC2} voltage		
8	V _{CC(B)}	V _{CC2}	supply voltage of system-2 (1.2 V to 5.5 V)		

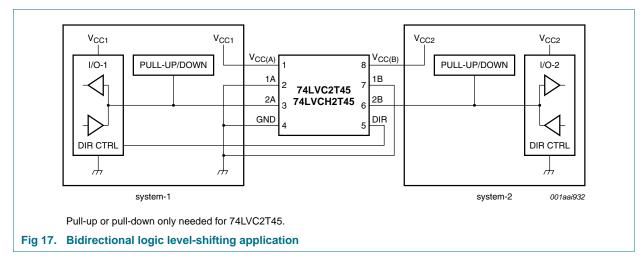
Table 16. Description of unidirectional logic level-shifting application

14.2 Bidirectional logic level-shifting application

Figure 17 shows the 74LVC2T45; 74LVCH2T45 being used in a bidirectional logic level-shifting application. Since the device does not have an output enable pin, the system designer should take precautions to avoid bus contention between system-1 and system-2 when changing directions.

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<u>Table 17</u> gives a sequence that will illustrate data transmission from system-1 to system-2 and then from system-2 to system-1.

			J	3 1 1 1
State	DIR CTRL	I/O-1	I/O-2	Description
1	Н	output	input	system-1 data to system-2
2	Н	Z	Z	system-2 is getting ready to send data to system-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on bus hold
3	L	Z	Z	DIR bit is set LOW. I/O-1 and I/O-2 still are disabled. The bus-line state depends on bus hold
4	L	input	output	system-2 data to system-1

Table 17. Description of bidirectional logic level-shifting application^[1]

[1] H = HIGH voltage level;

L = LOW voltage level;

Z = high-impedance OFF-state.

14.3 Power-up considerations

The device is designed such that no special power-up sequence is required other than GND being applied first.

Table 18.	Typical total	supply current	$(I_{CC(A)} + I_{CC(B)})$

V _{CC(A)}	V _{CC(B)}	V _{CC(B)}						
	0 V	1.8 V	2.5 V	3.3 V	5.0 V			
0 V	0	< 1	< 1	< 1	< 1	μA		
1.8 V	< 1	< 2	< 2	< 2	2	μΑ		
2.5 V	< 1	< 2	< 2	< 2	< 2	μA		
3.3 V	< 1	< 2	< 2	< 2	< 2	μA		
5.0 V	< 1	2	< 2	< 2	< 2	μΑ		

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14.4 Enable times

Calculate the enable times for the 74LVC2T45; 74LVCH2T45 using the following formulas:

- t_{PZH} (DIR to A) = t_{PLZ} (DIR to B) + t_{PLH} (B to A)
- t_{PZL} (DIR to A) = t_{PHZ} (DIR to B) + t_{PHL} (B to A)
- t_{PZH} (DIR to B) = t_{PLZ} (DIR to A) + t_{PLH} (A to B)
- t_{PZL} (DIR to B) = t_{PHZ} (DIR to A) + t_{PHL} (A to B)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the 74LVC2T45; 74LVCH2T45 initially is transmitting from A to B, then the DIR bit is switched, the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.

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15. Package outline

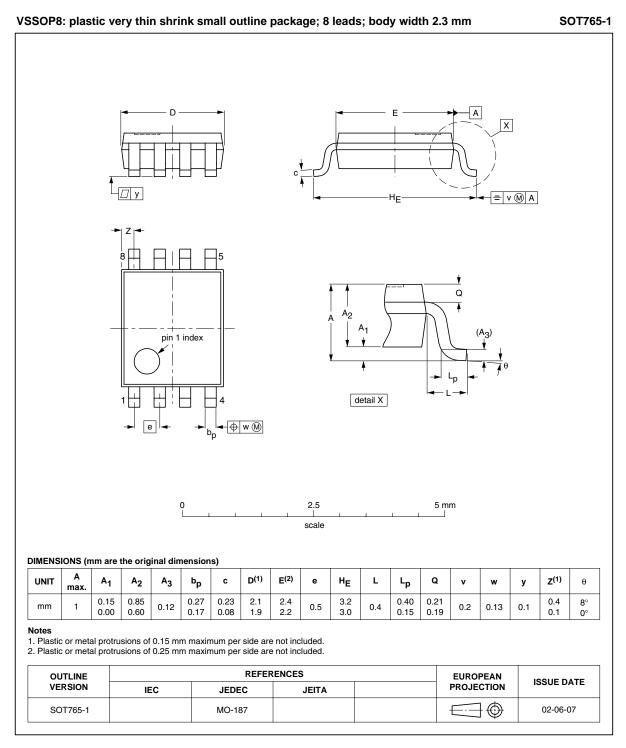


Fig 18. Package outline SOT765-1 (VSSOP8)

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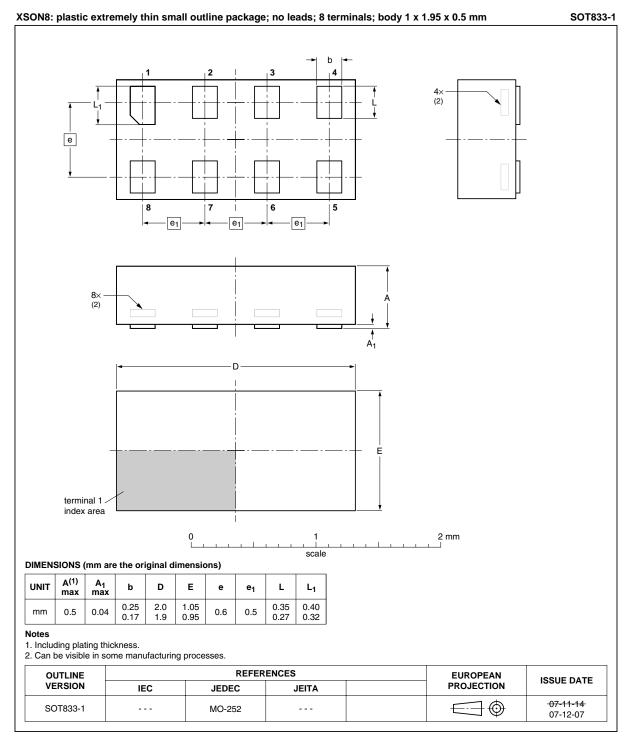
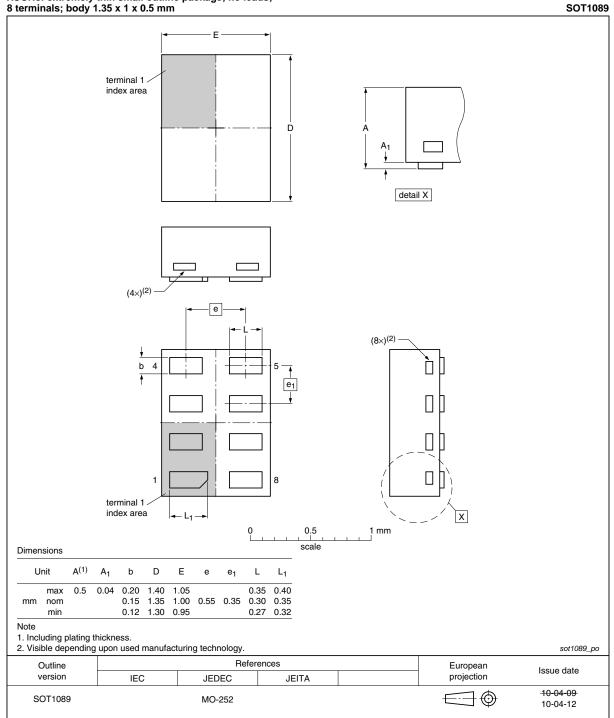


Fig 19. Package outline SOT833-1 (XSON8)

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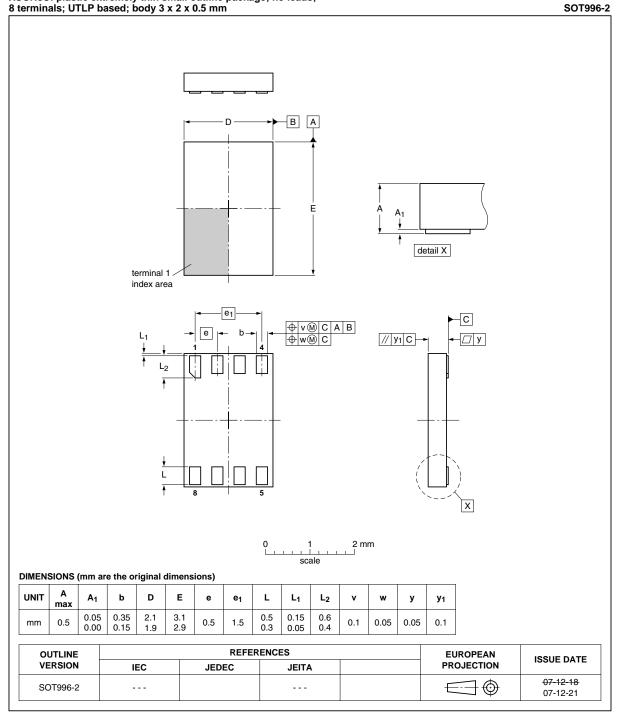
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XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1 x 0.5 mm

Fig 20. Package outline SOT1089 (XSON8)

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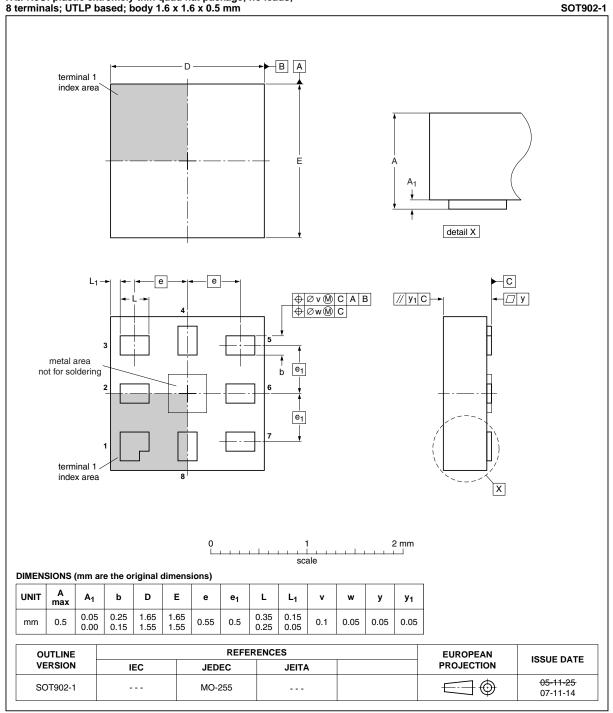


XSON8U: plastic extremely thin small outline package; no leads; 8 terminals; UTLP based; body 3 x 2 x 0.5 mm

Fig 21. Package outline SOT996-2 (XSON8U)

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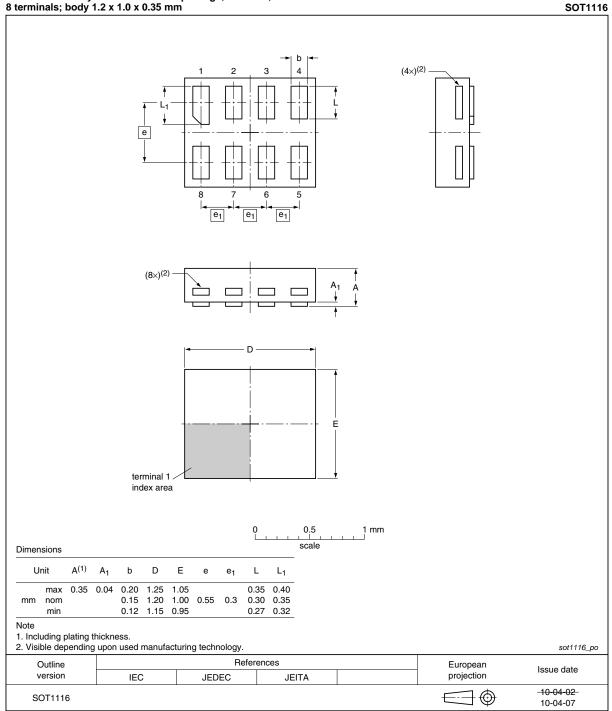


XQFN8U: plastic extremely thin quad flat package; no leads; 8 terminals; UTLP based; body 1.6 x 1.6 x 0.5 mm

Fig 22. Package outline SOT902-1 (XQFN8U)

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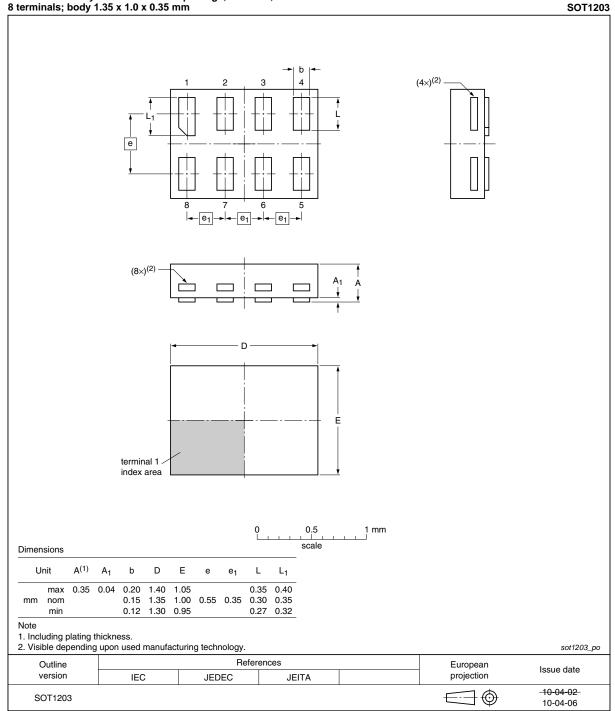


XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.2 x 1.0 x 0.35 mm

Fig 23. Package outline SOT1116 (XSON8)

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XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1.0 x 0.35 mm

Fig 24. Package outline SOT1203 (XSON8)

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16. Abbreviations

Table 19. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			

17. Revision history

Table 20. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC_LVCH2T45 v.4	20100820	Product data sheet	-	74LVC_LVCH2T45 v.3
Modifications:	 Added type 	number 74LVC2T45GF (SC	0T1089/XSON8 package	e).
	 Added type 	number 74LVCH2T450GF ((SOT1089/XSON8 pack	age).
	 Added type 	number 74LVC2T45GN (SC	OT1116/XSON8 package	e).
	 Added type 	number 74LVCH2T45GN (S	SOT1116/XSON8 packa	ge).
	 Added type 	number 74LVC2T45GS (SC	OT1203/XSON8 packag	e).
	 Added type 	number 74LVCH2T45GS (S	SOT1203/XSON8 packa	ge).
74LVC_LVCH2T45 v.3	20100119	Product data sheet	-	74LVC_LVCH2T45 v.2
74LVC_LVCH2T45 v.2	20090205	Product data sheet	-	74LVC_LVCH2T45 v.1
74LVC_LVCH2T45 v.1	20081118	Product data sheet	-	-

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18.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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